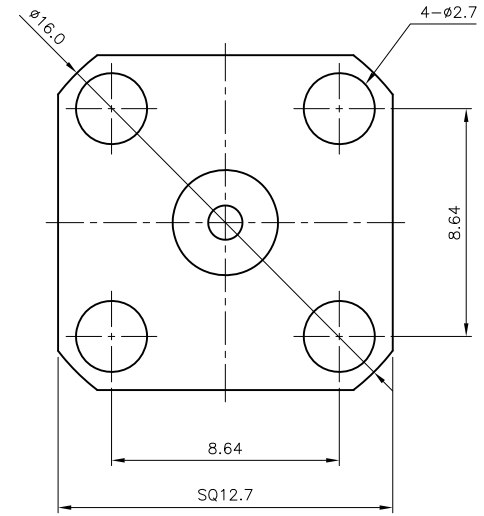
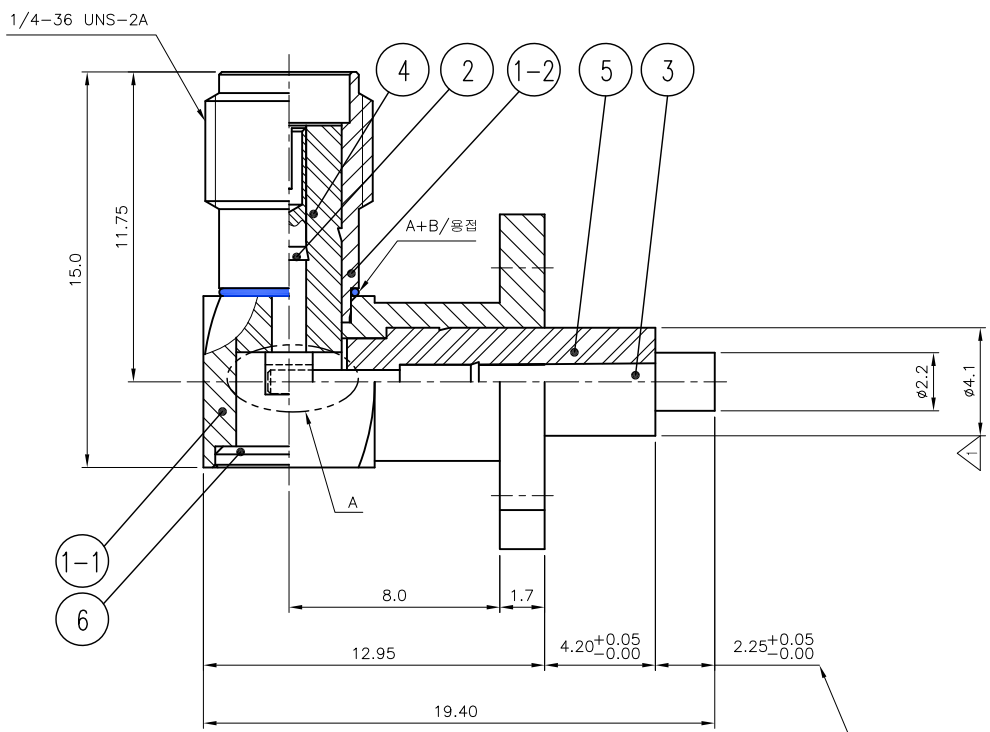
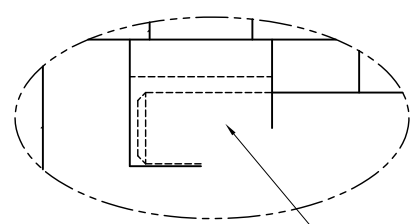


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
1	Initial Registration	I.C.KIM		2019.09.26
1	[설번No.202104-0003] 바디 PUNCH -> HOOK 변경 및 A+B/용접 구조 적용	S.Y.EUN	I.C.KIM	2021.04.09
2	바디 공용화로 인한 코드 변경	S.Y.EUN	I.C.KIM	2021.07.06
8	TP00087-7/2 작음 길이 변경	K.S.KIM	S.L.SON	2022.11.16



TAP LOSS 특성 중요 POINT



②,③ PIN 납땜시 과납 하지 말 것. (과납시 특성 안 좋아짐)

6	COVER	1	MBsBD C3604BD-F	Gold Plate	DCO00038-5/1
5	INSULATOR	1	TEFLON		DIN03087-N/4
4	INSULATOR	1	TEFLON		DIN00112-N/1
3	CONTACT	1	MBsBD C3604BD-F	Gold Plate	DCT04065-5/4
2	CONTACT	1	BsCu C17300	Gold Plate	DCT00151-5/1
1	1-2 BODY (B)	1	MBsBD C3604BD-F	Gold Plate	DBD02134-1/3
	1-1 BODY (A)	1	MBsBD C3604BD-F	Gold Plate	DBD00167-5/6 DBD00229-1/6
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	±0.3	APPROVED BY	S.L.SON		
	Angle	CHECKED BY	S.L.SON	TITLE	
	±1°	DRAWN BY	K.S.KIM		
MATERIAL	_____			SMA50 PCB JL-4R	
FINISH	_____	SCALE	UNIT	A3	DWG NO.
		5/1	mm		UNIT
					REVISION
					8
					SHEET
					1 of 1